

Neutron Imaging Detector based on the μ PIC

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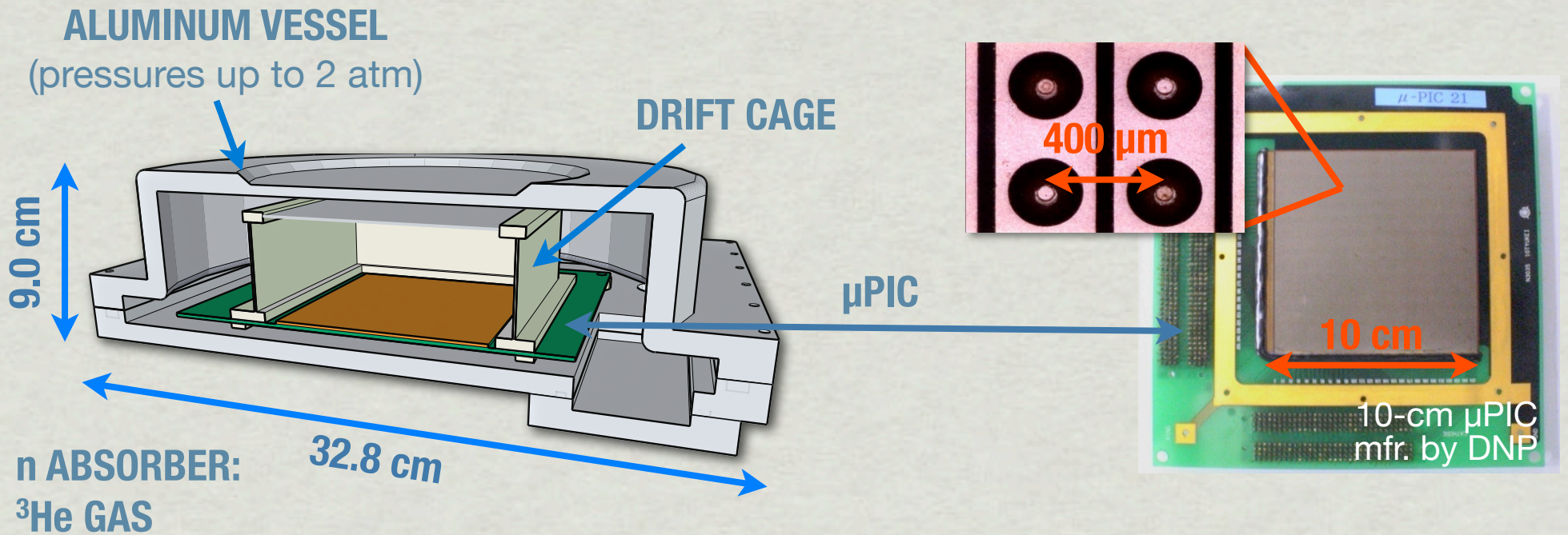
JAPAN ATOMIC ENERGY AGENCY, MATERIALS AND LIFE SCIENCE FACILITY DIVISION

M. Harada, T. Oku, T. Shinohara, J. Suzuki

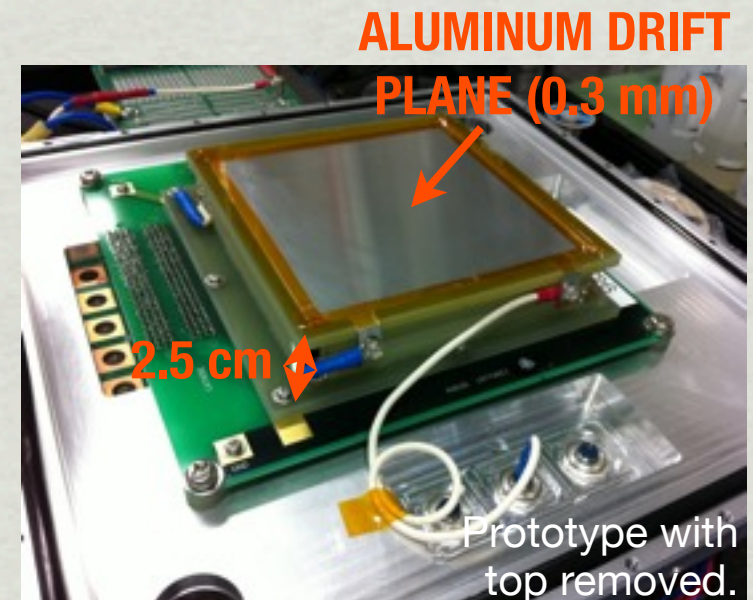
Neutron Imaging Detector based on the μ PIC

- * **Prototype system and basic operation.**
- * **Demonstration measurements.**
- * **Future improvements.**

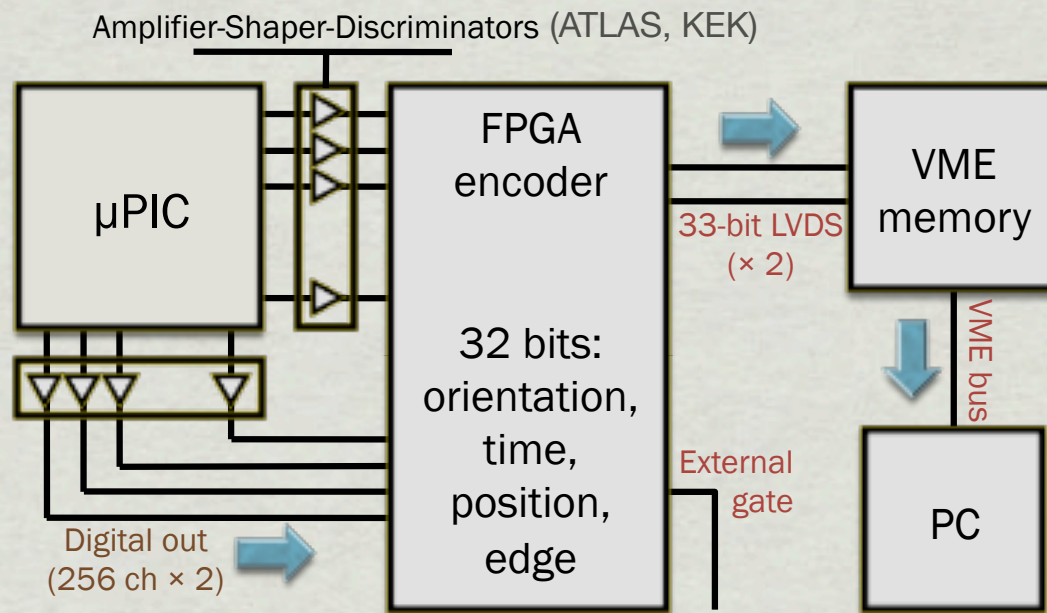
Neutron imaging detector prototype (μ NID)



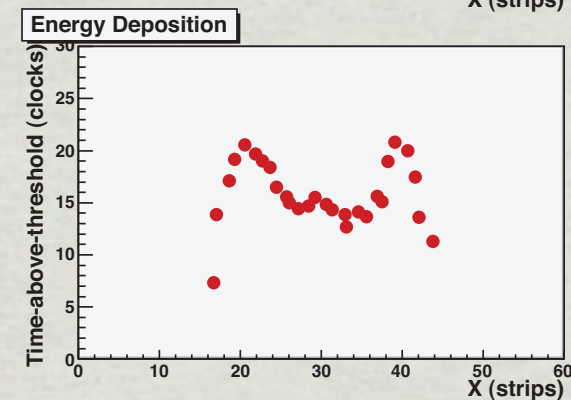
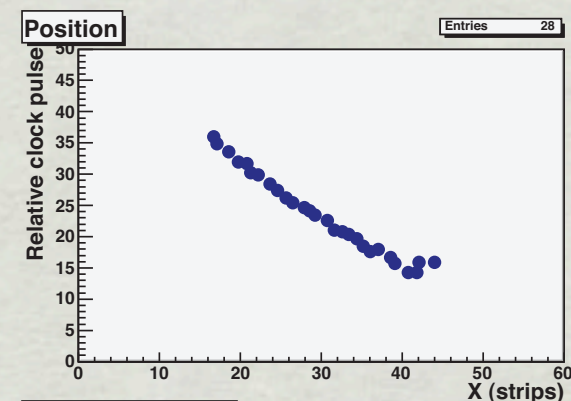
- * High-rate FPGA-based DAQ.
- * TPC measures 3D proton-triton tracks.
- * Energy deposition estimated by time-above-threshold method.
- * Gas gain < 1000 for neutron imaging.
- * Efficiency up to $\sim 30\%$, position res. of $\sim 120 \mu\text{m}$, time res. of $\sim 1 \mu\text{s}$.



DAQ and FPGA logic

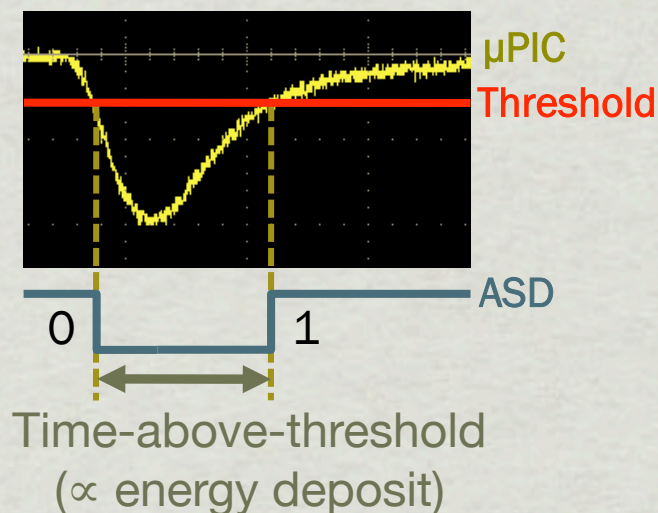


PROTON-TRITON TRACKS



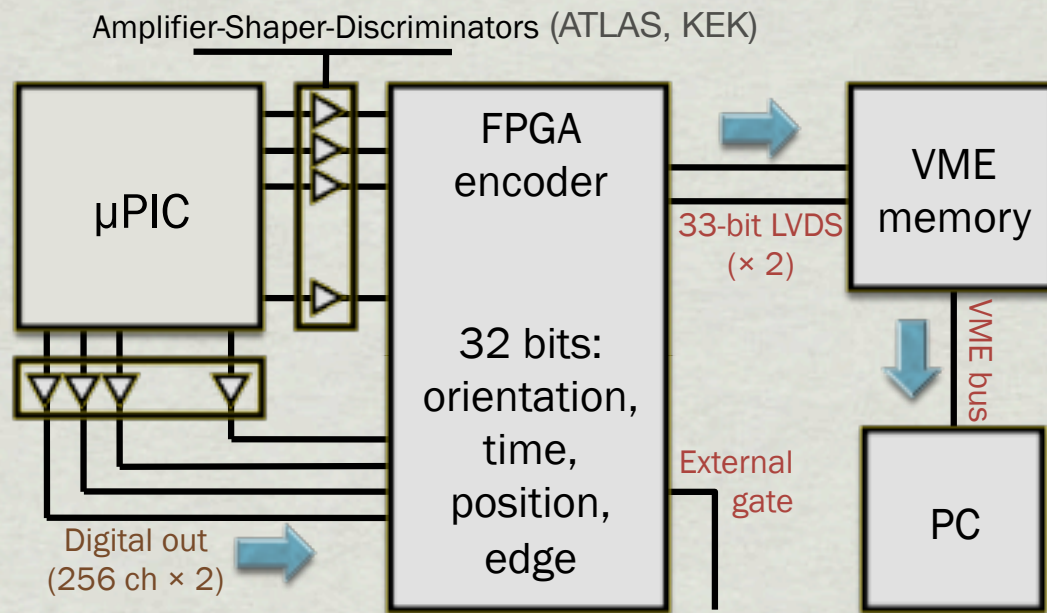
DATA ENCODING

- * Two words per pulse.
- * 'edge bit' saved with each data word.

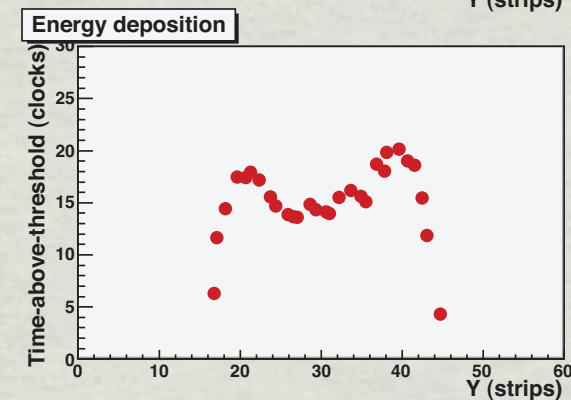
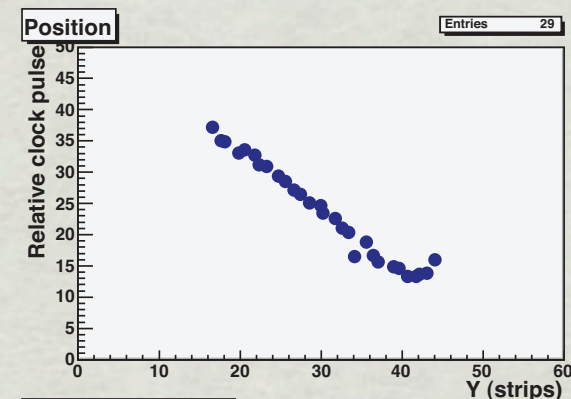


- * Simultaneous measurement of position and 'energy deposit' at high rates.
- * Excellent background rejection capability.

DAQ and FPGA logic

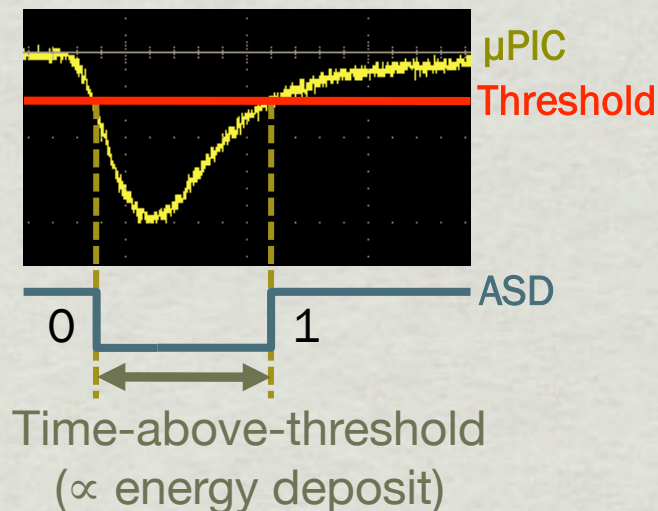


PROTON-TRITON TRACKS



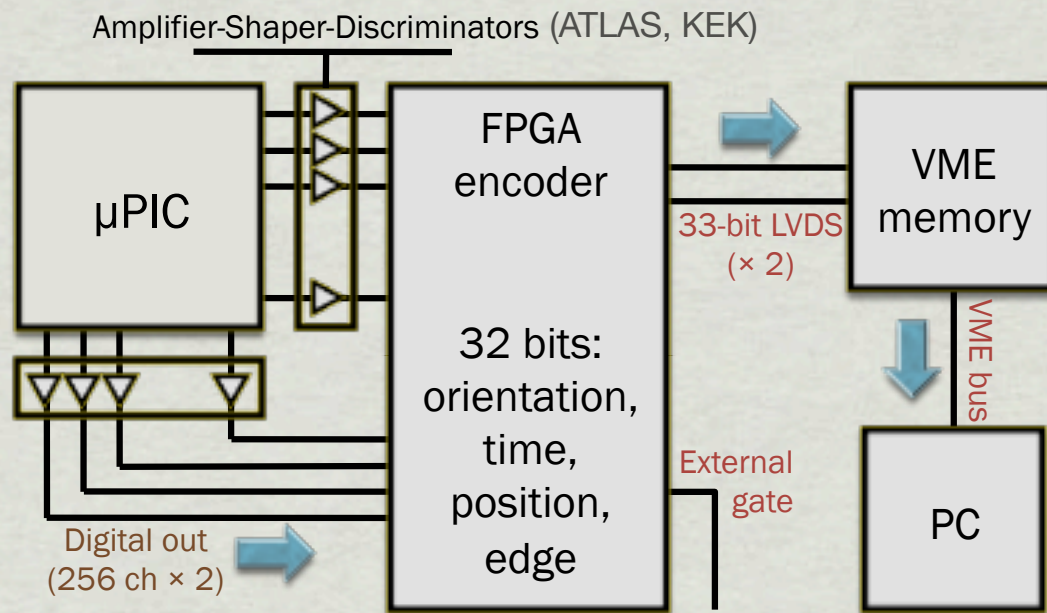
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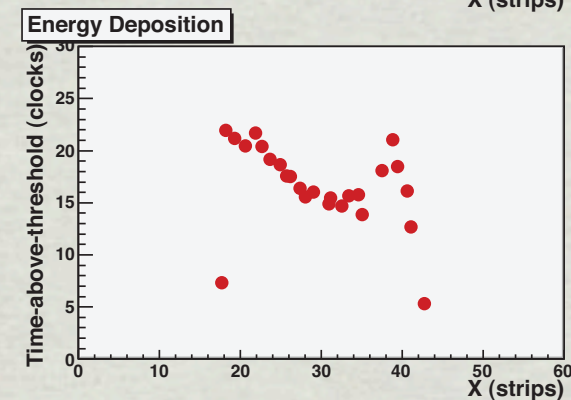
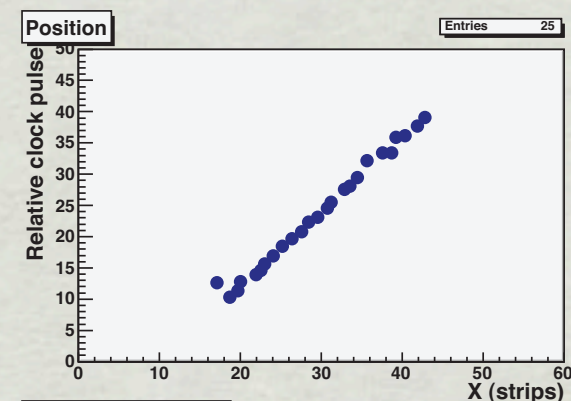


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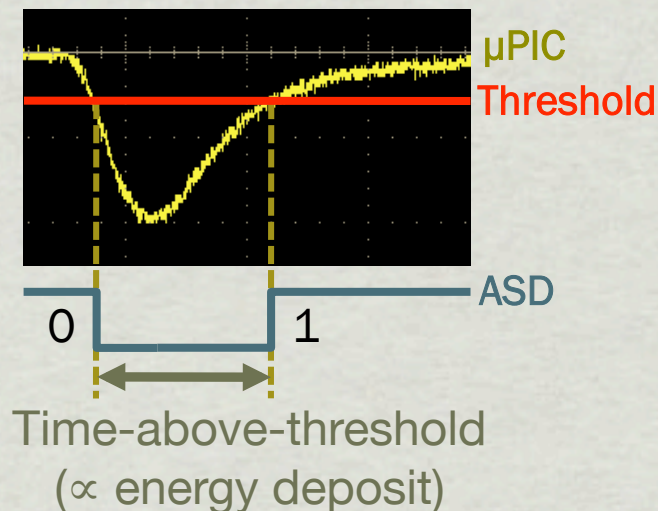


PROTON-TRITON TRACKS



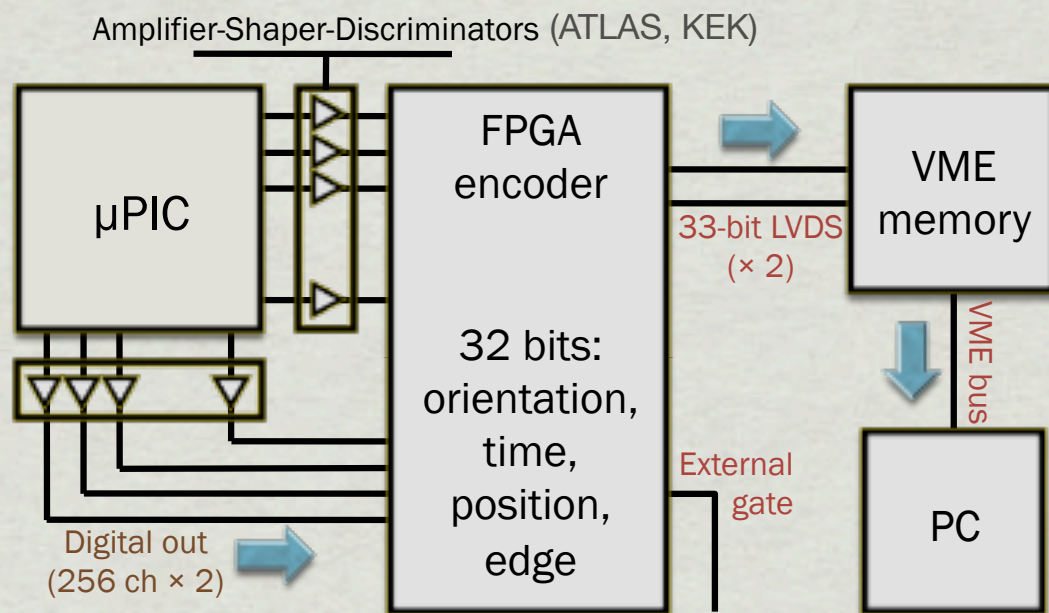
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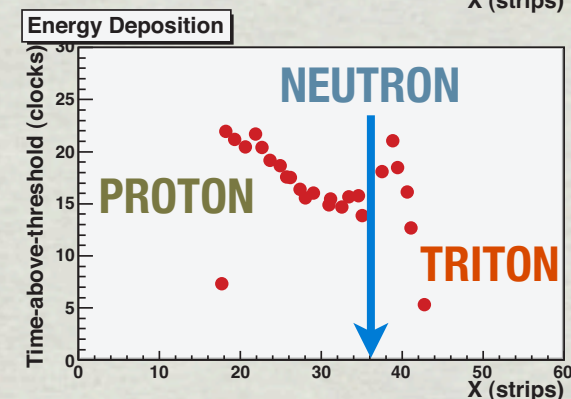
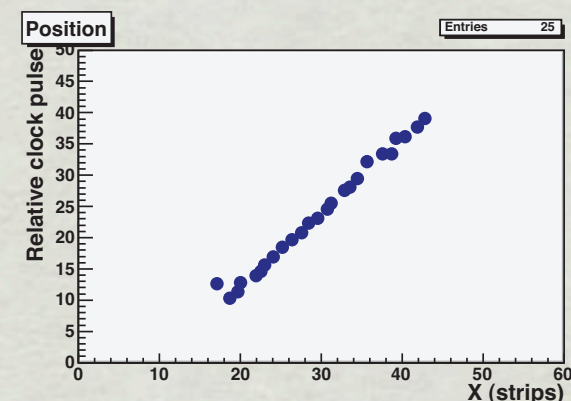


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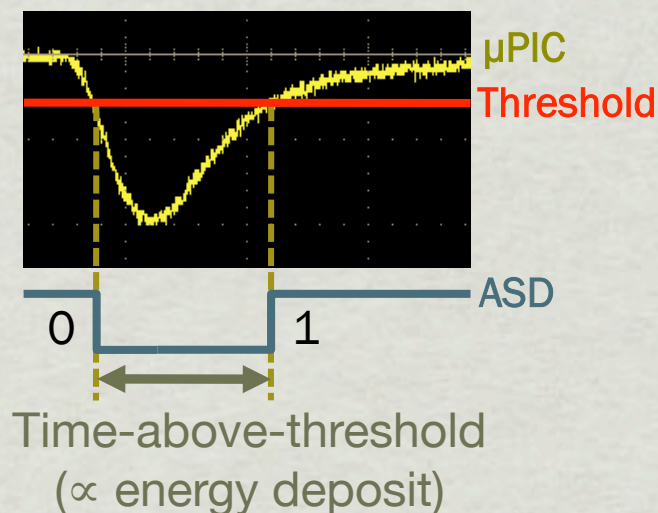


PROTON-TRITON TRACKS



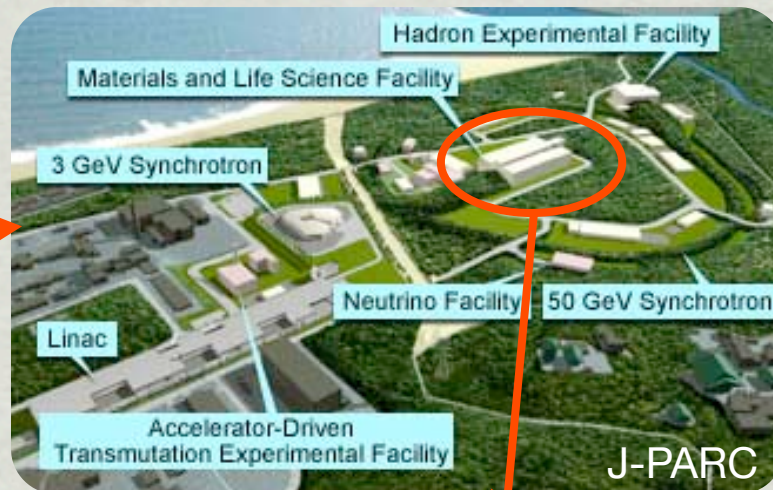
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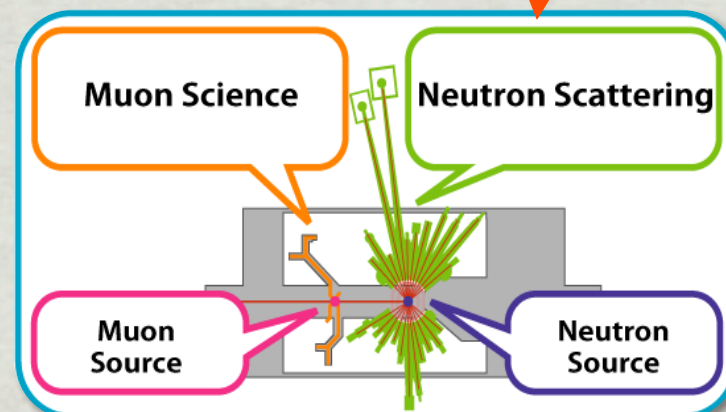


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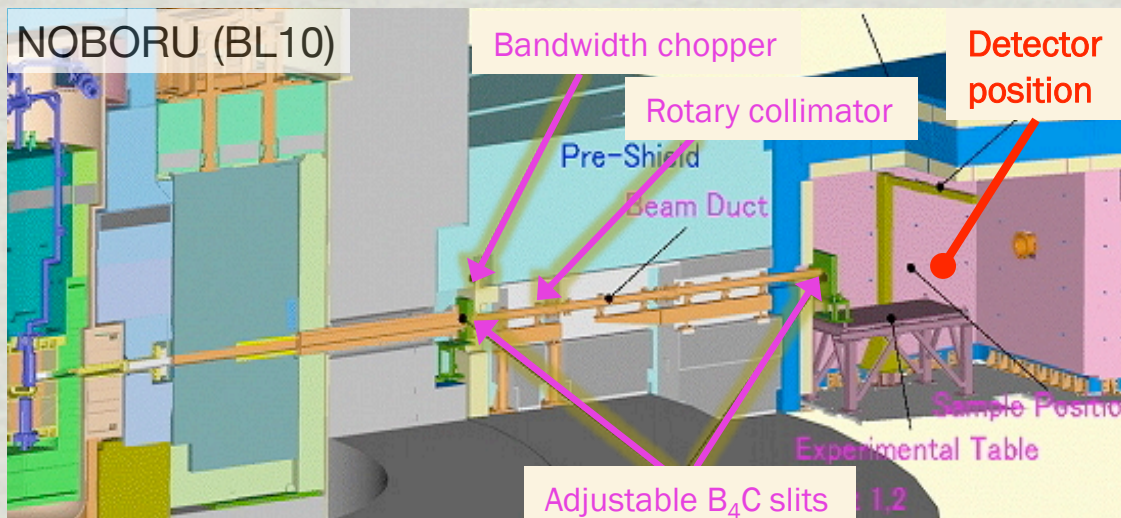
Test experiments at J-PARC



- * Experiments in Nov. 2009, June 2010, and Feb. 2011.
- * Beam power ~120 kW.
- * Carried out at NOBORU beam line.
- * Fill gas: Ar-C₂H₆-³He (63:7:30) at 2 atm, efficiencies ~28%(5 cm), ~13%(2.5 cm).



Materials and Life Science Facility (MLF)

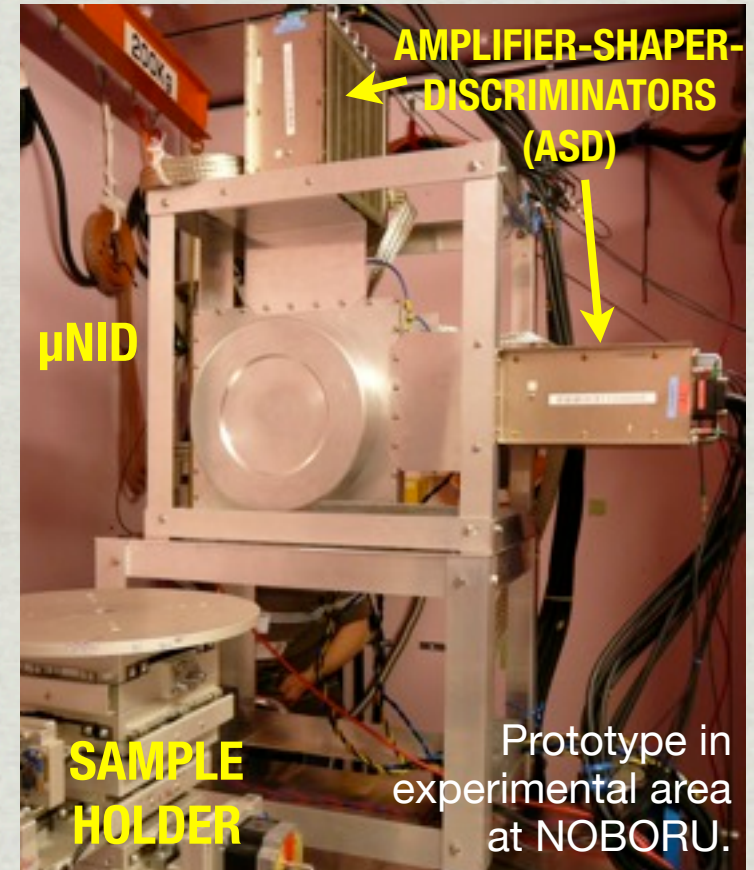


NOBORU BEAM LINE

- * Moderator-to-detector distance of ~14.5 m.
- * Max. beam size: 10 × 10 cm².
- * 25 Hz pulse rate, 10 Å bandwidth.

Long term operability and ^3He usage

- * Same gas filling used for first two experiments (separated by 8 months).
- * No degradation in performance seen in June experiment.
- * Gain recovered by increasing anode voltage.
- * **Detector remained operable after more than 1 year on single gas filling.**



	Time after filling	Gain (% of initial)
1 st Exp (2009)	0 months	100
2 nd Exp (2010)	8 months	67
Dec 2010	13 months	30

Strategies to extend operation

- * Annealing of vessel and μPIC against outgassing.
- * Careful selection of materials.
- * Gas purification or ^3He reclamation system.

DAQ performance at NOBORU

- * Time-averaged data rates from 200 kHz ~ 9.4 MHz (neutron rate of 80~100 kHz).
- * Large dead time (40 ~ 85%).
- * Encoder limits DAQ rate.
- * VME-to-PC transfer creates dead time.
- * **Limitations can be reduced with further hardware development.**

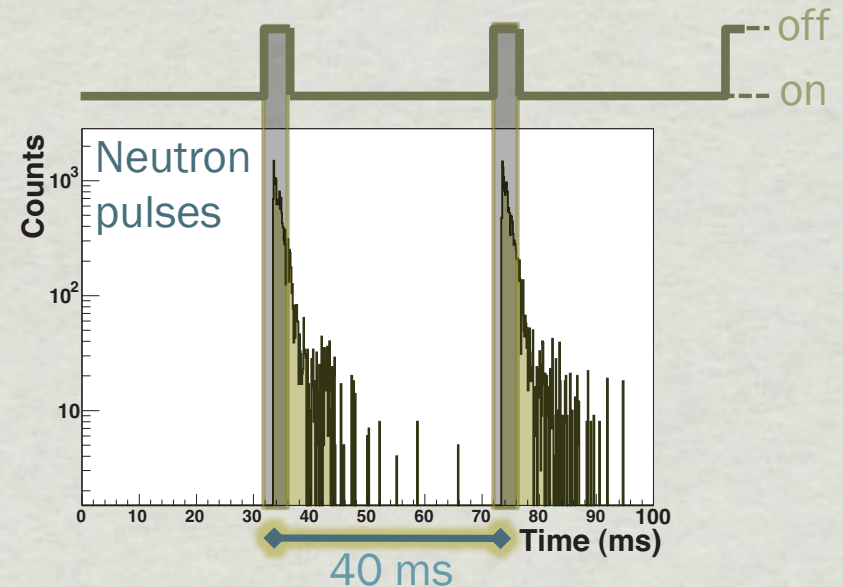
EXTERNAL TOF GATE

Ex: Bragg transmission measurement (2010).

	Ungated	TOF > 3 ms
No. of pulses	8948	191389
Total time (min)	34.5	226.2
Dead time (%)	82.7	43.6

~70% decrease in measurement time.

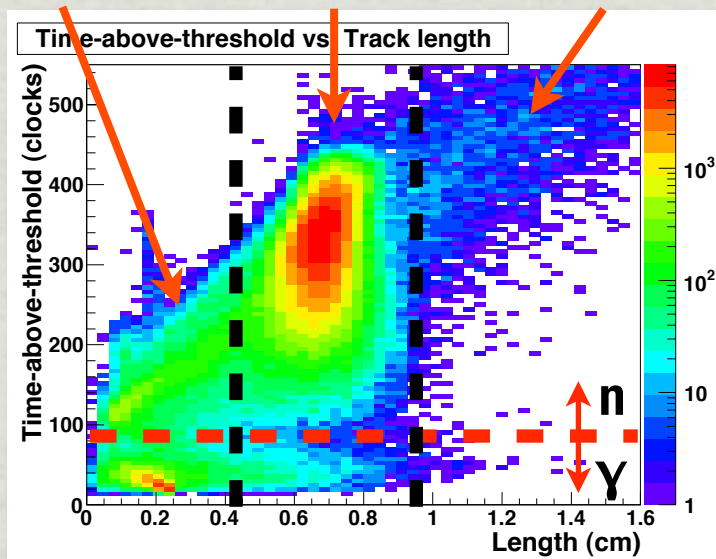
EXTERNAL TOF GATE



- * Reduction in incoming data means fewer VME readouts.
- * Effectiveness depends on details of TOF distribution and gate.
- * Useful for Bragg transmission, resonance absorption.

Neutron-gamma separation

Escape events Fully-contained neutrons Event pile-up, scattered protons

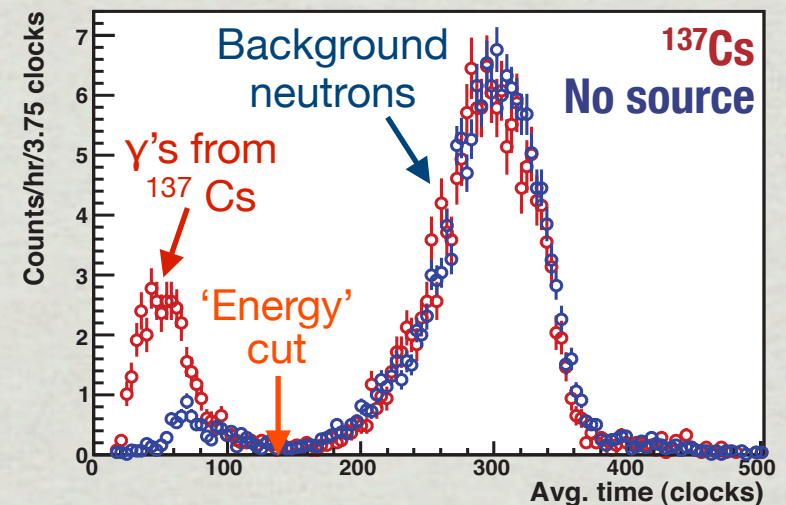


- * Both neutrons and gammas are detected (γ efficiency $\sim 10^{-3}$).
- * Neutrons selected by cuts in total time-above-threshold and 3D track length.
- * Fraction of detected γ 's surviving neutron cuts $< 10^{-6}$ (effective gamma sensitivity of $< 10^{-9}$).

- * Gamma rejection studied using RI sources.

- * Data taken over 24 hours.

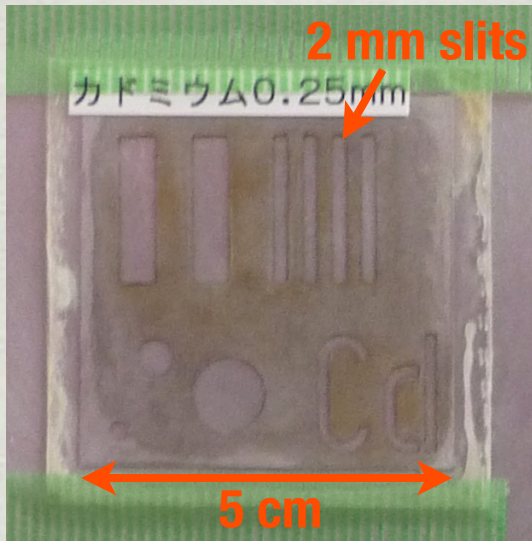
Pulse-width sum after track-length cut



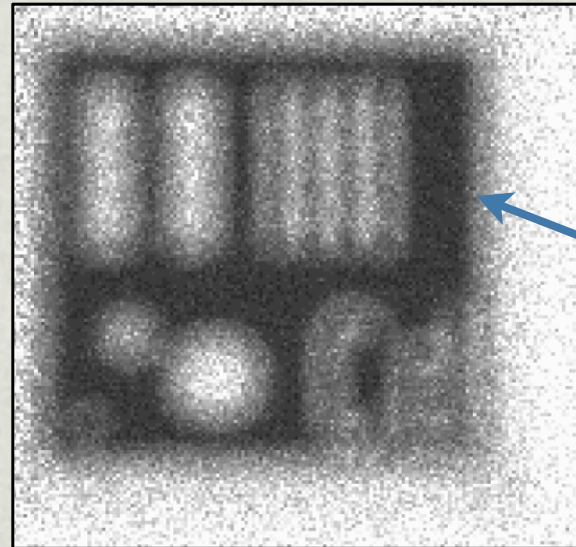
	Contamination fraction (95% CL)
Track length	$< 5.5 \times 10^{-6}$
+ PID	$< 2.9 \times 10^{-6}$

Position resolution with PID

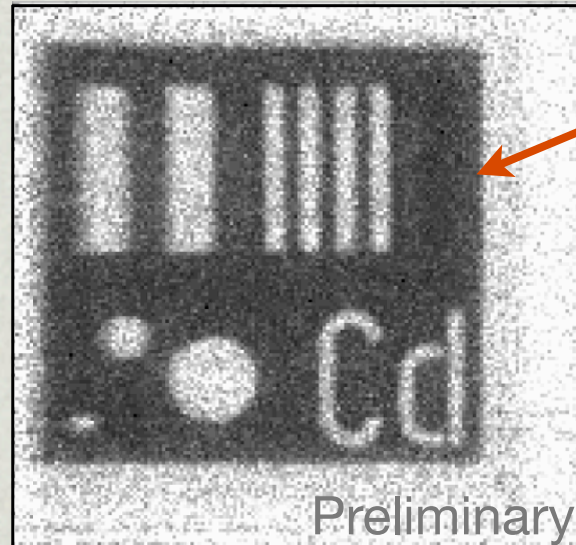
Cd TEST CHART



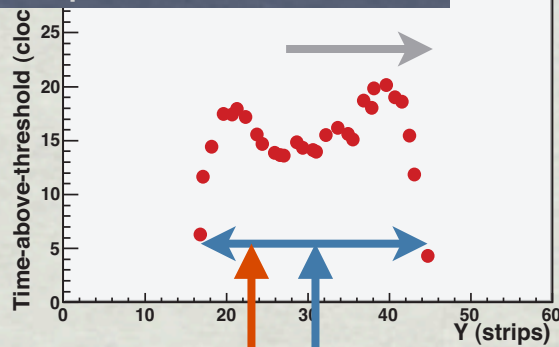
No PID



With PID



Proton direction from shape of distribution



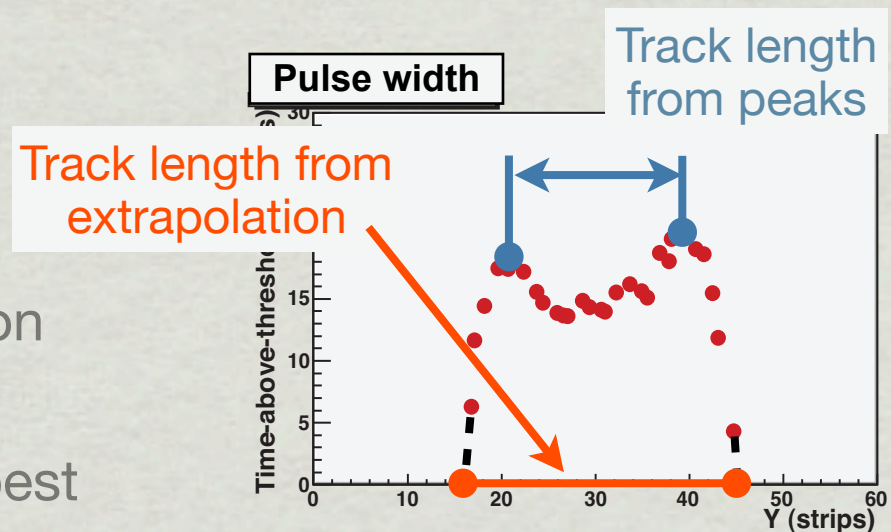
Corrected position

Mid-point

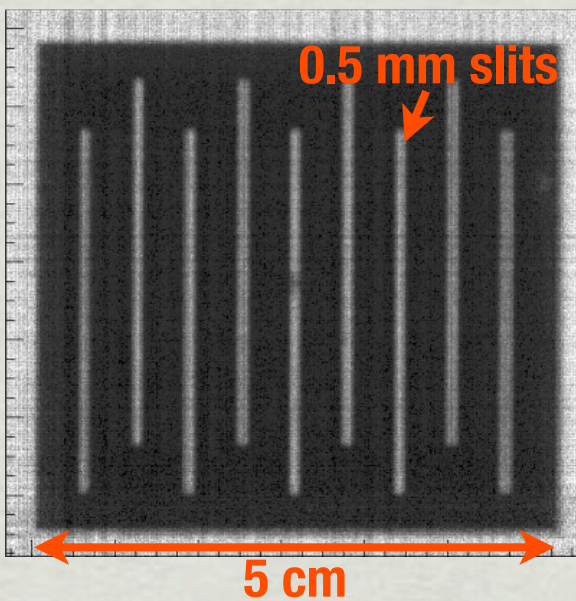
Data taken at NOBORU, J-PARC in Nov. 2009.

Refining position resolution

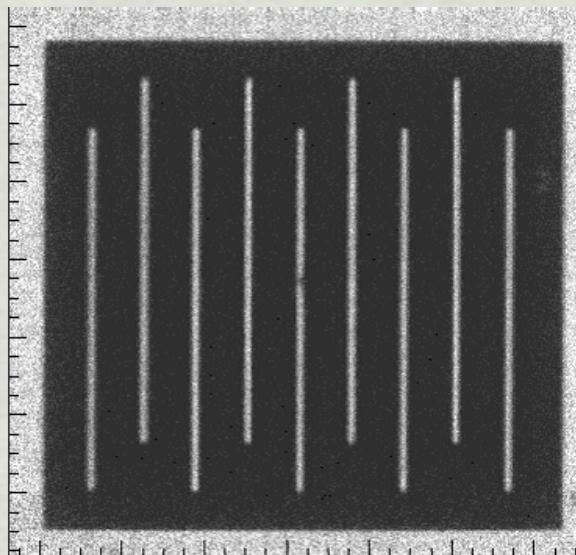
- * Two methods: End-Point Extrapolation (EPE) and Peak Interpolation (PI).
- * Combining both methods produces best result of $\sigma = 118.4 \pm 0.2 \mu\text{m}$.



NO REFINEMENT
($\sigma = 315 \mu\text{m}$)



EPE ONLY
($\sigma = 182 \mu\text{m}$)



EPE + PI
($\sigma = 118 \mu\text{m}$)

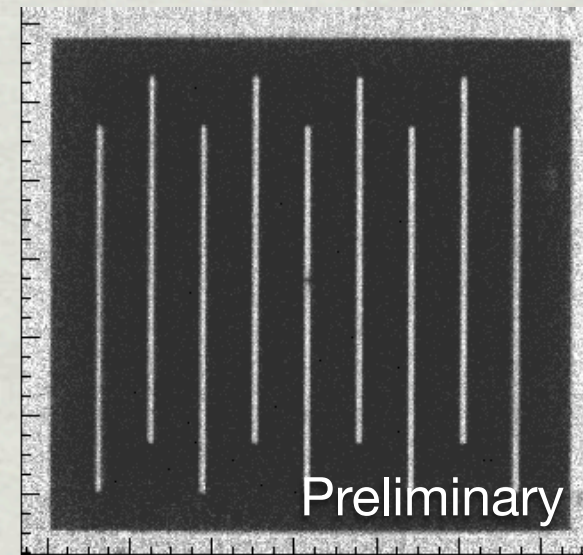
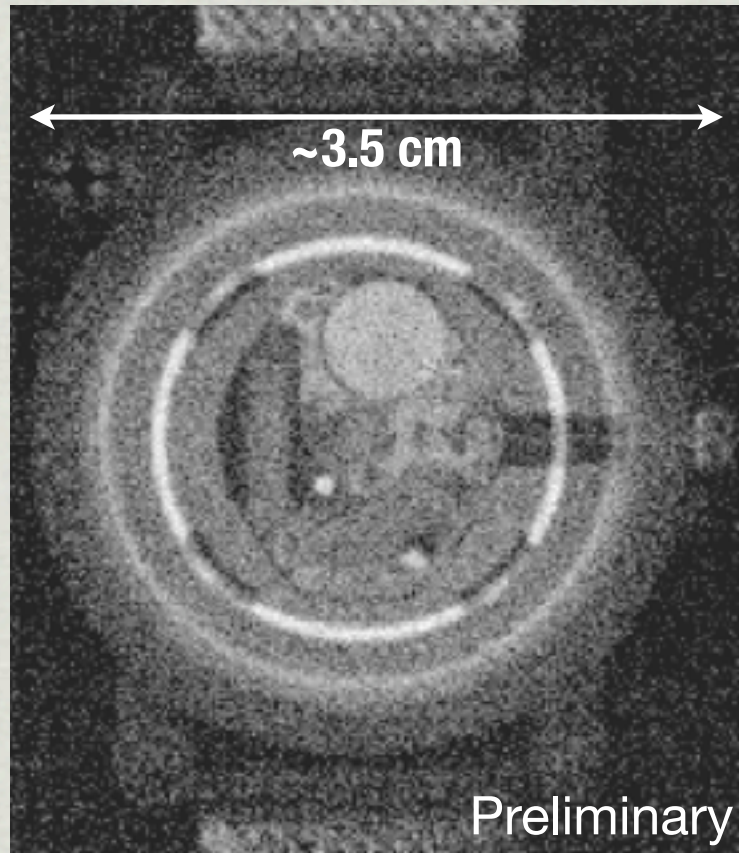


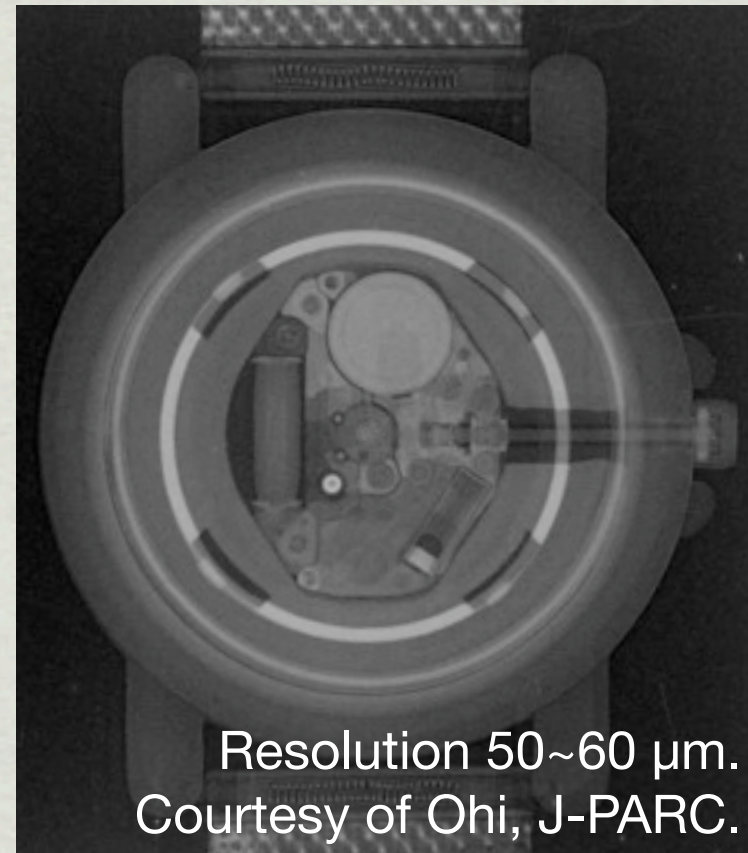
Image of a wristwatch

μ PIC (29 MIN.)



Bin size: $200\ \mu\text{m} \times 200\ \mu\text{m}$.

IMAGING PLATE (200 MIN.)

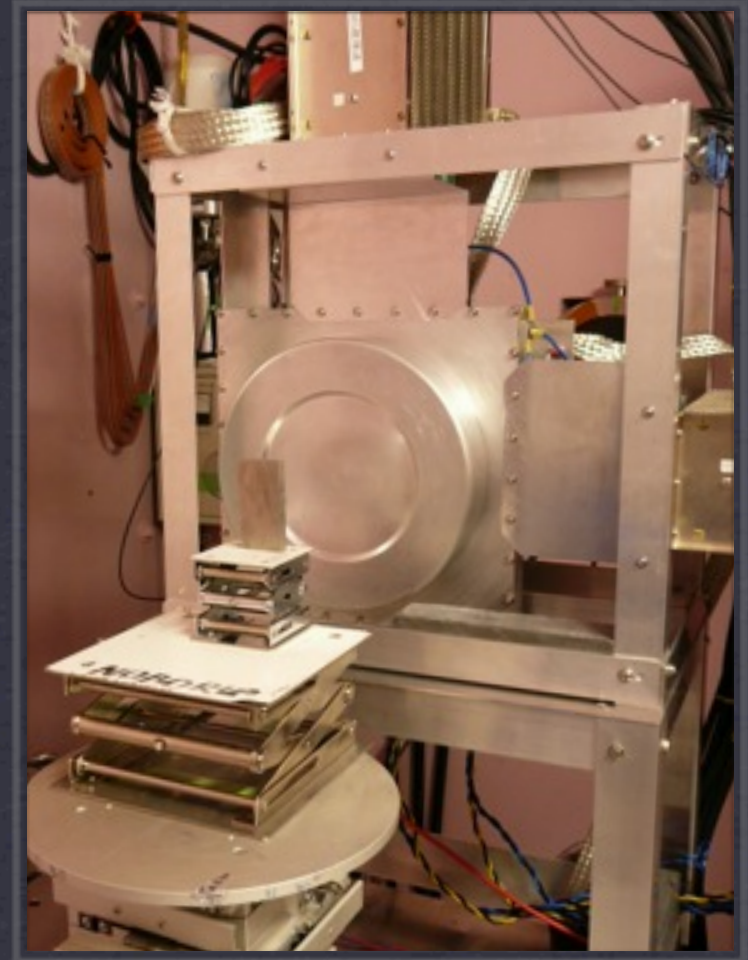


- * Bin size can be decreased with higher statistics.
- * Image processing techniques could improve image.

Data taken at NOBORU, J-PARC in Feb. 2011 (μ PIC).

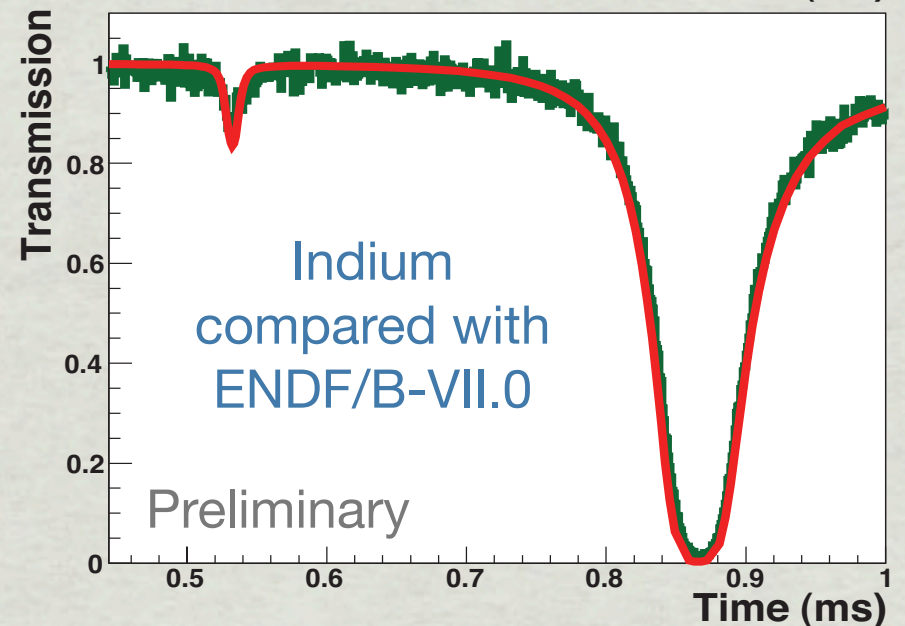
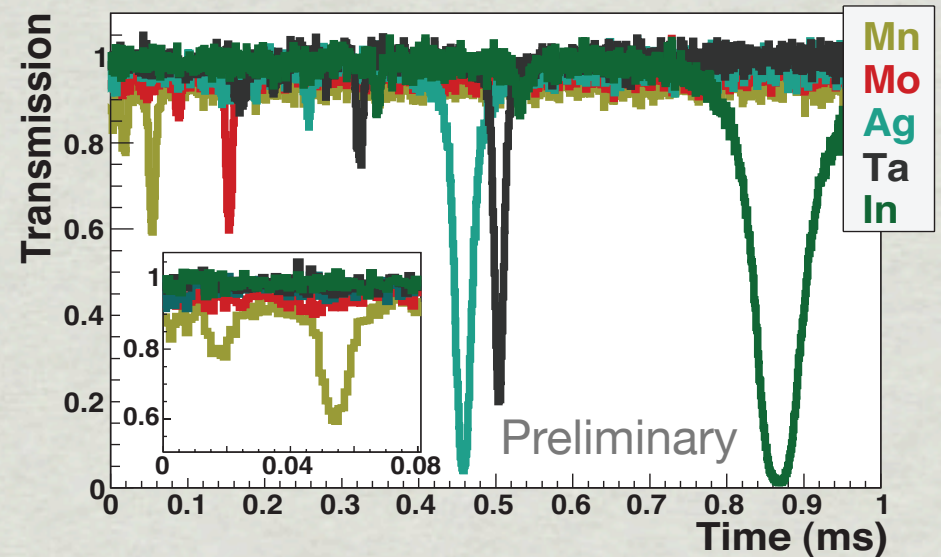
Demonstration measurements

- * Resonance absorption.
- * Bragg-edge transmission.



Resonance absorption

- * Sheets of In, Ta, Ag, Mo, and Mn.
- * Typical area of 10 cm × 10 cm.
- * Thicknesses from 10 μm to 1 mm.
- * Resonance absorption occurs when neutrons of a particular energy are absorbed preferentially by a target nucleus.
- * Large samples to accumulate statistics quickly (~16 min/sample).
- * Good time resolution and background rejection allows us to see resonances near beginning of pulse.



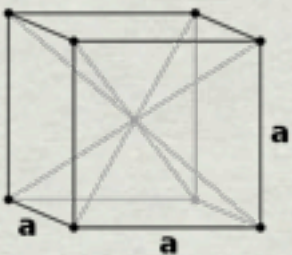
Bragg-edge transmission



Fe powder (> 99% purity, grain size < 325 μm).

Fe CRYSTAL STRUCTURE

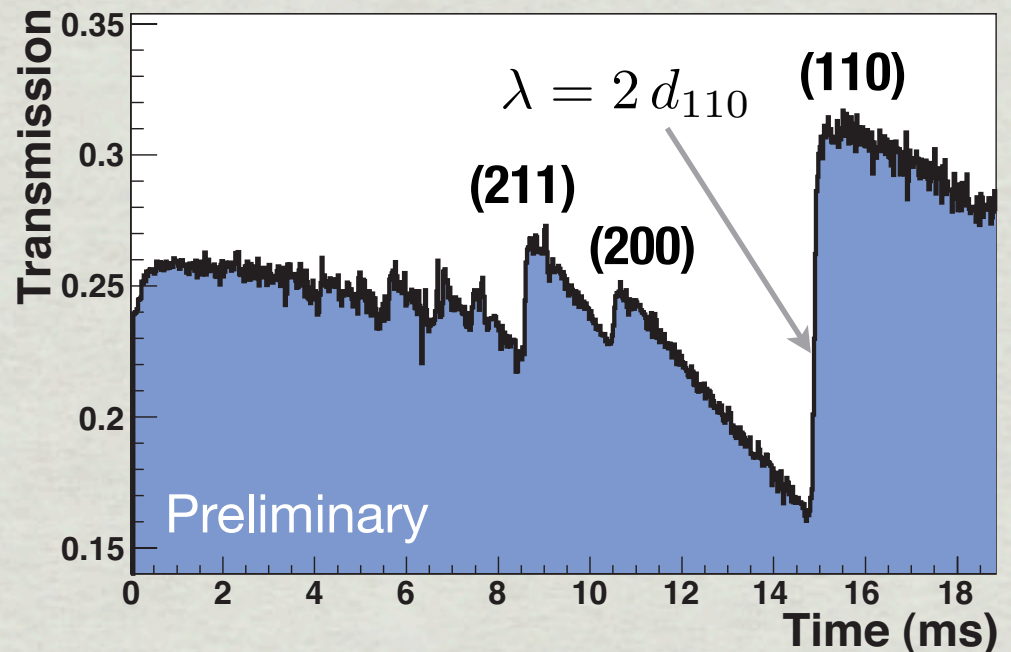
Body-centered cubic (BCC)



a is referred to as the lattice parameter.

$$a = d_{lmn} \sqrt{l^2 + m^2 + n^2}$$

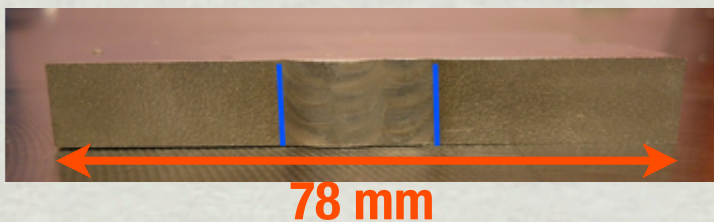
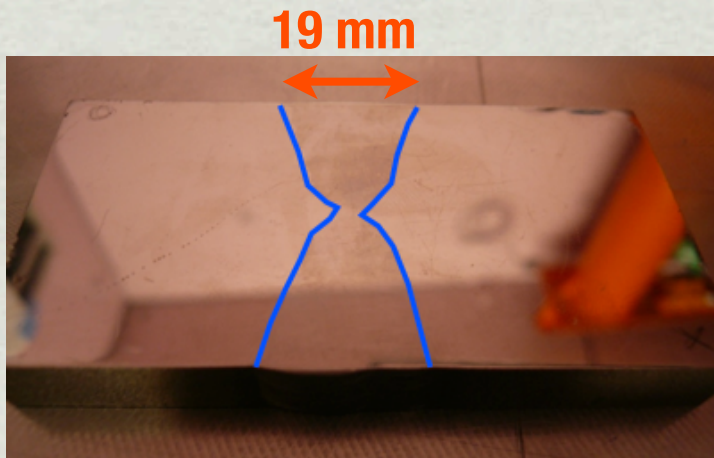
- * Edges appear when neutron wavelength is twice crystal plane spacing (Bragg's law at $2\theta = 180^\circ$).
- * Edge spacing is consistent with expected BCC crystal structure.
- * Precise measurement of edge positions determines lattice parameter.



Data taken at NOBORU, J-PARC in Feb. 2011.

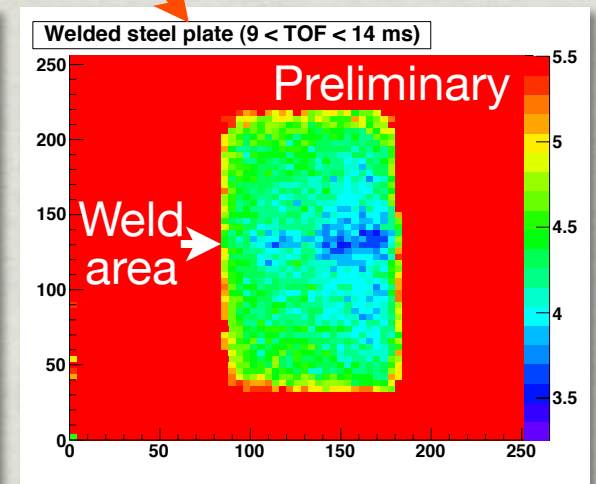
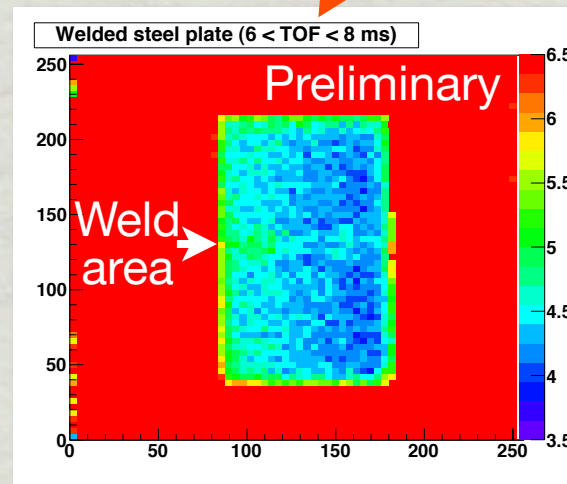
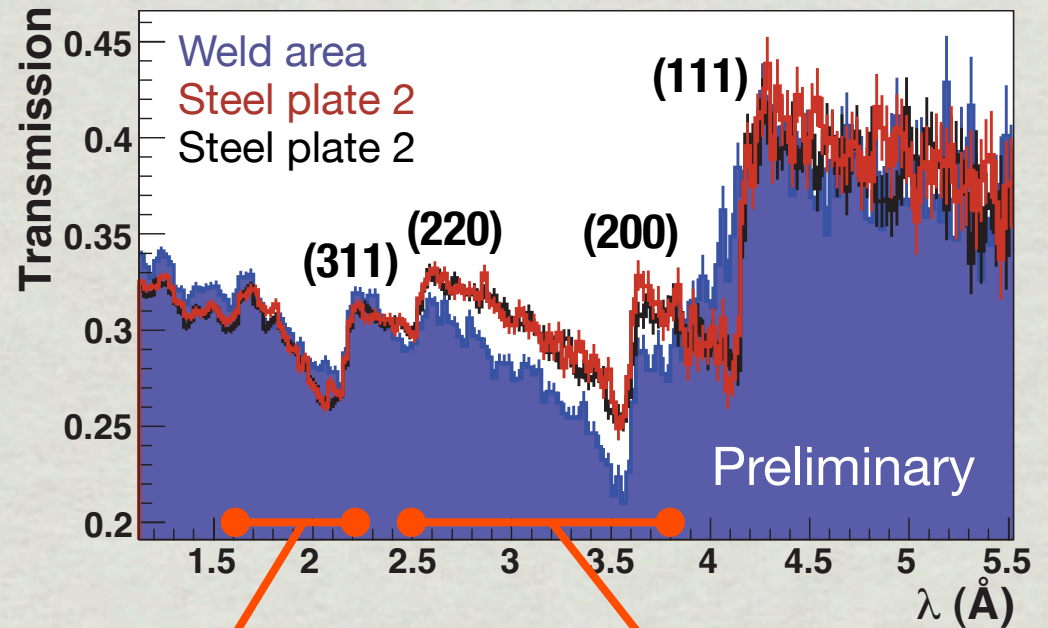
Bragg-edge transmission

78 × 40.5 × 10 mm³ TIG-WELDED
316L STAINLESS STEEL PLATE



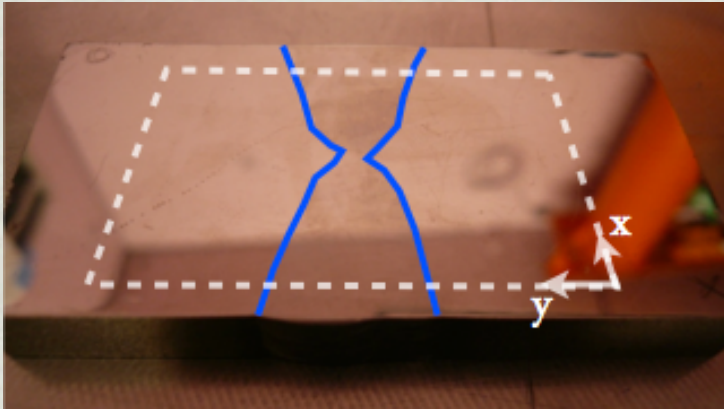
Edge spacing is consistent with FCC crystal structure.

Transmission vs. neutron wavelength



Data taken at NOBORU, J-PARC in June 2010.

Bragg-edge transmission



Divide image into $4.8 \times 4.8 \text{ mm}^2$ 'pixels' and fit edge positions*.

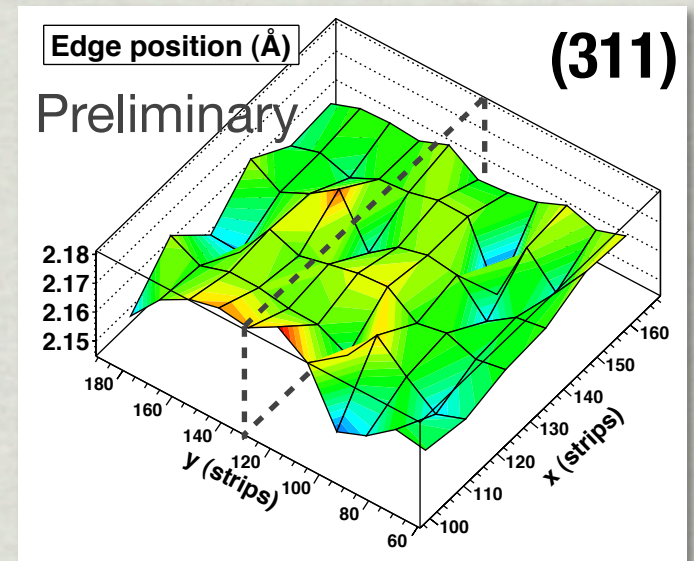
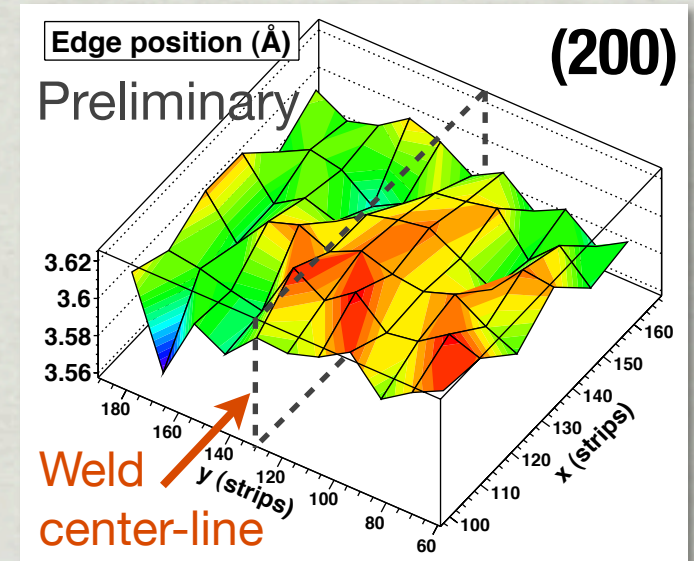
- * Variation in edge positions may be related to internal strain.
- * Full strain tensor requires measurements from at least six independent directions.
- * Only one direction observed in this measurement.

$$d = \frac{\lambda}{2}$$

d-spacing from wavelength

$$\varepsilon = \frac{d - d_0}{d_0}$$

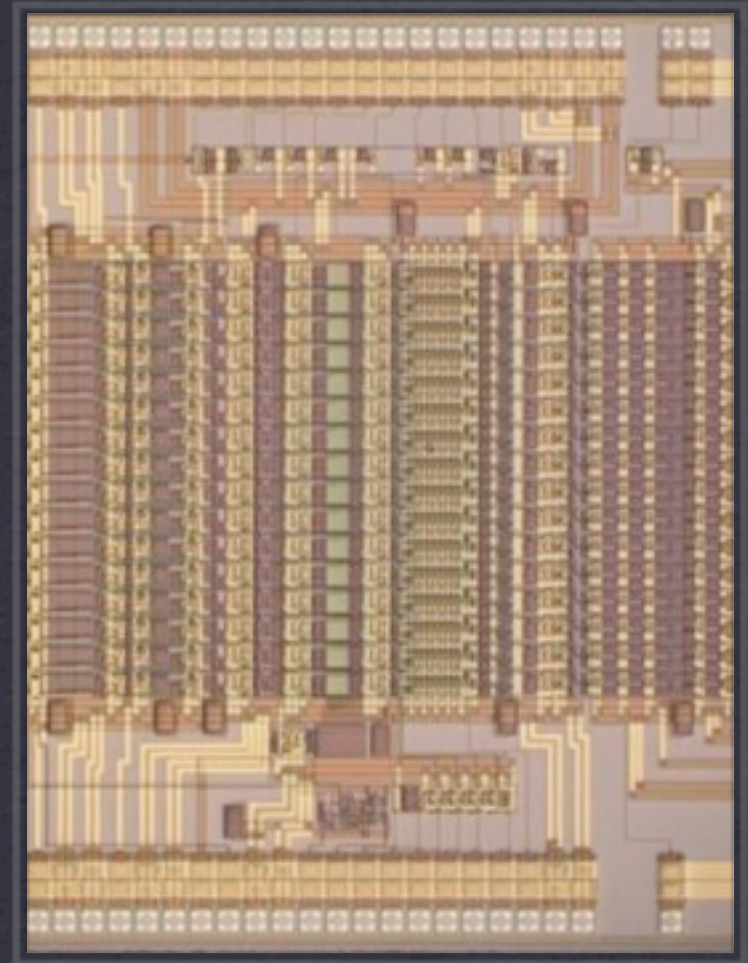
strain component in beam direction



* Fit procedure based on Santisteban, et al. (2001)

Future improvements

- * Optimization of gas mixture.
- * Smaller pitch μ PIC.
- * New ASICs and encoder for more compact DAQ.



Gas optimization and pixel pitch

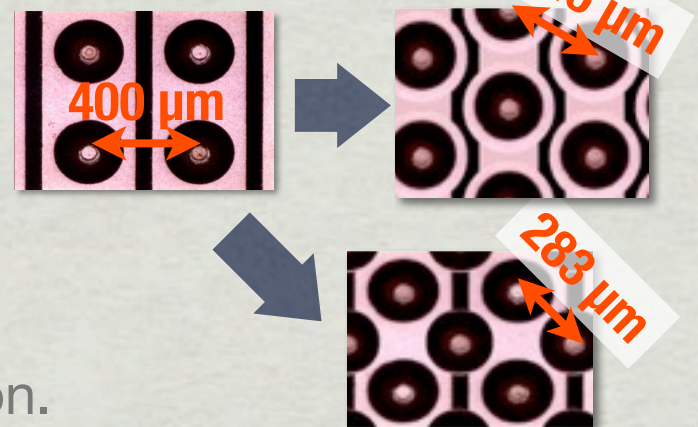
	Pressure (atm)	Drift velocity ($\mu\text{m}/\text{ns}$)	Transverse diffusion ($\mu\text{m}/\text{cm}^{1/2}$)	Longitudinal diffusion ($\mu\text{m}/\text{cm}^{1/2}$)	Expected improvement in resolution
Ar:C ₂ H ₆ : ³ He (63:7:30)	2	23.1	273	169	(118 μm)
Ar:C ₂ H ₆ : ³ He (63:7:30)	3	23.4	231	126	~15%
Xe:C ₂ H ₆ : ³ He (50:20:30)	2	29.4	183	125	~15%
Ar:CO ₂ : ³ He (50:20:30)	2	22.5	107	114	~15%

Gas parameters determined by MAGBOLTZ.

Resolutions estimated with GEANT4.

- * Shorten p-t track lengths by increasing pressure or changing to gas with higher stopping power.
- * Reduce diffusion of drift electrons.
- * Moderate reductions in pixel pitch produce corresponding reduction in position resolution.

Denser packing of anode pixels



Gas optimization and pixel pitch

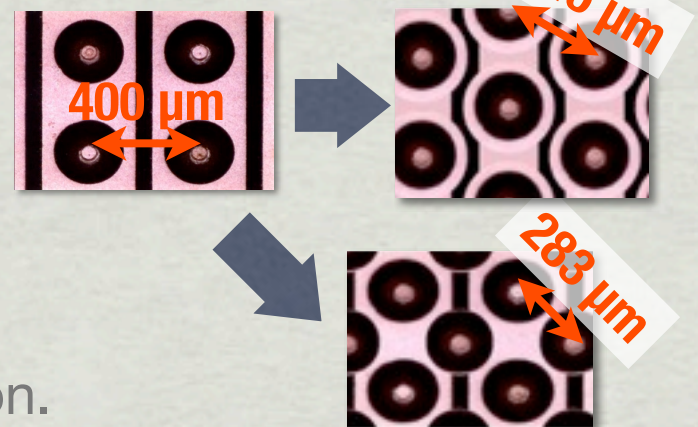
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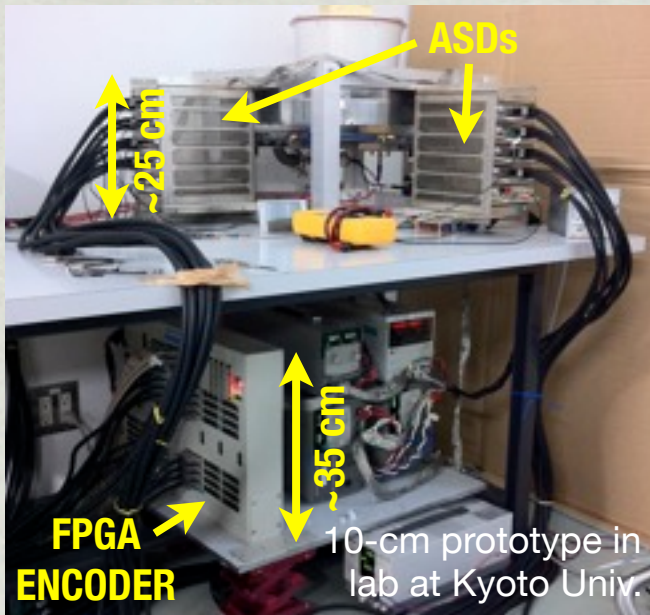
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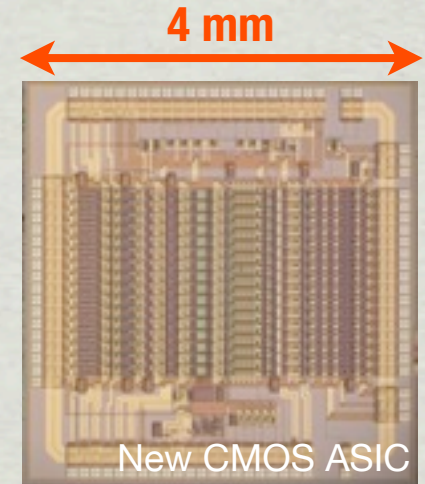
Denser packing of anode pixels



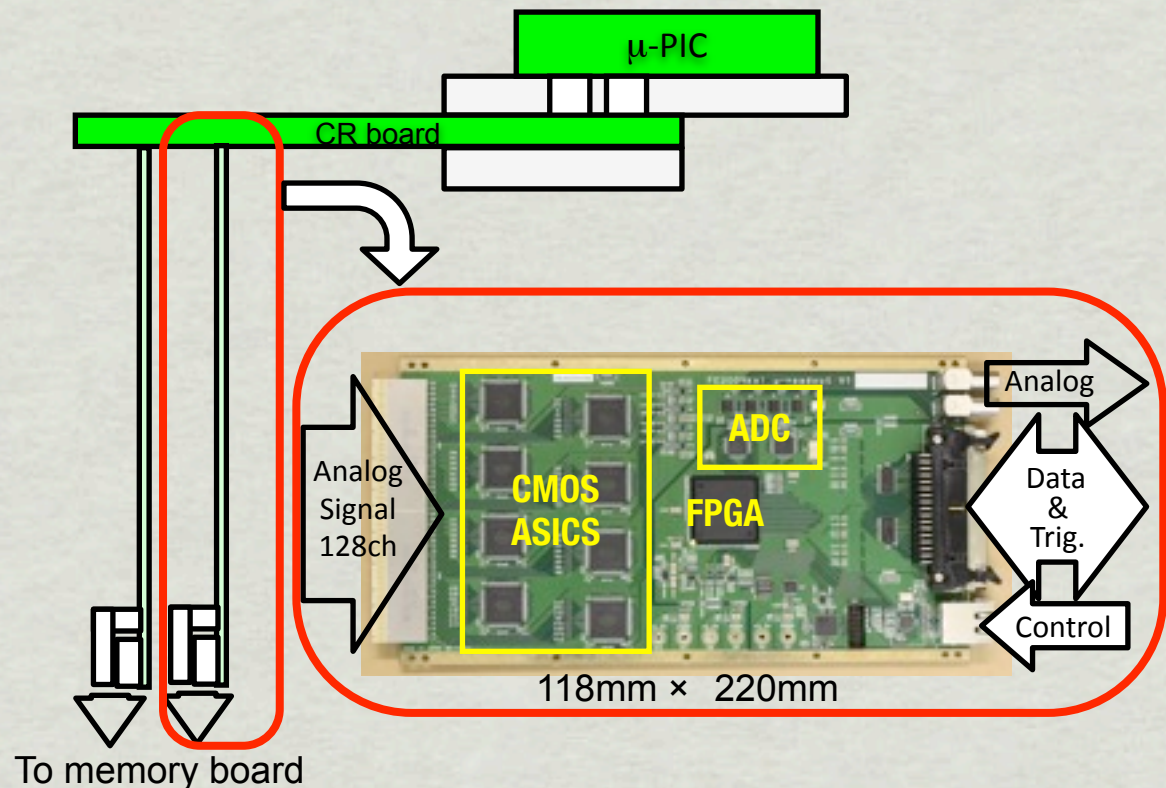
DAQ improvements



- * Replace ASDs with CMOS chips (developed with KEK for SMILE project).
- * 16 channels/chip (increased from 4).
- * Power per channel reduced by factor of more than 3.



- * Combine CMOS chips with FPGA on single board.
- * Four boards replace ASD racks, encoder, cables.
- * Each board writes to memory, increasing max. data rate.
- * New boards now under testing.



Summary

- * TPC based on micro-pattern gaseous detector and FPGA DAQ system.
 - * Position resolution of **118 μm** ; time resolution of **$\sim 1 \mu\text{s}$** .
 - * FPGA-based DAQ with high data rates.
 - * Strong rejection of gammas and fast neutrons.
- * Detector remains operable over long time.
 - * Annealing to reduce outgassing for increased long-term stability.
 - * Gas filtration system could extend operation considerably.
- * Development of compact DAQ and optimization of gas mixture are ongoing.
- * μPIC manufactured using standard, inexpensive PC board manufacturing processes.
 - * μPIC sizes up to $30 \times 30 \text{ cm}^2$ are currently available.
 - * Tiling of detectors to cover large area.